

09/736,462  
SC0853AM

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: Tan, Aik Chong et al.

Serial No.: 09/736,462

Filing Date: MAY 15 2003 December 12, 2000.

Group Art Unit: 2831

Examiner: PROGRAMS EXAMINER OFFICE OF THE SPECIAL AGENT, HUNG V

Title: BUMP CHIP LEAD FRAME AND PACKAGE

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JAN 14 2003

TECHNOLOGY CENTER 2800

I HEREBY CERTIFY THAT THIS CORRESPONDENCE IS BEING FACSIMILE  
TRANSMITTED TO THE PATENT AND TRADEMARK OFFICE,

ATTN EXAMINER NGO, HUNG V AT THE FAX NO. (703) 872-9319

ON:

January 14, 2003

Date of Facsimile Transmission

15 pages

LYDIA MCNAMARA

Name of Person Signing Certificate

Lydia McNamara

SIGNATURE

1/14/2003

DATE

Box DAC, Assistant Commissioner for Patents,  
Washington, D.C. 20231

Honorable Commissioner of Patents,  
Washington, D.C. 20231

REQUEST TO RECONSIDER HOLDING OF ABANDONMENT

The above identified patent application became  
abandoned for failure to timely file a proper reply to the  
Office letter mailed on May 9, 2002. A response to the above  
Office letter was signed and timely filed with the USPTO by

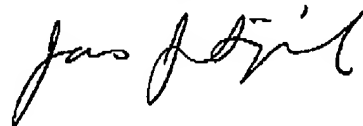
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fax on July 8, 2002, which was within the shortened statutory period. The Notice of Abandonment was subsequently received on December 20, 2002. Included herewith is a copy of the fax confirmation report showing Group Art Unit 2831 received the Office Action Response and a copy of the Office Action Response, which is used to provide *prima facie* evidence that the USPTO did receive the Office Action Response.

In view of the above remarks and attached exhibits, the Applicants believe the holding of abandonment from failure to timely file a proper reply incorrect, and respectfully request the examiner reconsider the holding of abandonment, as there is no abandonment in fact.

While no fees are believed due, the Commissioner is authorized to collect appropriate fees which may be due from Deposit Account 501086.

Respectfully submitted,  
Tan, Aik Chong et al.



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Date: Jan. 14, 2003

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Jan-14-2003 11:11am From-

T-393 P.003 F-075

ATTACHMENT 1

AMENDMENT AFTER FINAL ACTION PURSUANT TO 37 CFR §  
1.116 INCLUDING FAX CONFIRMATION REPORT

Confirmation Report - Memory Send

Date & Time: Jul-08-2002 02:54pm  
Tel line :  
Machine ID :

Job number : 821  
Date & Time : Jul-08 02:51pm  
To : 9-1-7038729319  
Number of pages : 011  
Start time : Jul-08 02:51pm  
End time : Jul-08 02:54pm  
Pages sent : 011  
Status : OK

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Job number : 821

\*\*\* SEND SUCCESSFUL \*\*\*

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09/736,462

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In re Application of: Tan, Aik Chong et al.  
Serial No.: 09/736,462  
Filing Date: December 12, 2000  
Group Art Unit: 2831  
Examiner: NGO, HUNG V  
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TRANSMITTED TO THE PATENT AND TRADEMARK OFFICE, ATTN EXAMINER  
NGO, HUNG V AT THE FAX NO. (703) 872-3313

ON: July 8, 2002  
Date of Facsimile Transmission

Lydia M. McManis  
Name of Person Signing Certificate  
Lydia McManis  
SIGNATURE

11 pages  
7/8/2002  
DATE

Honorable Commissioner of Patents,  
Washington, D.C. 20231

AMENDMENT AFTER FINAL ACTION PURSUANT TO 37 C.F.R. § 1.115  
SIR:

In response to the office action mailed May 9, 2002,  
Applicants respectfully request that the Examiner  
reconsider and further examine the application in view of  
the following amendments and/or comments.